TOSHIBA Field Effect Transistor Silicon P Channel MOS Type ($L^2-\pi$ -MOSVI)

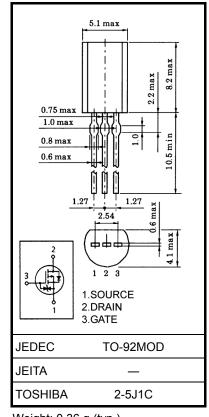
2SJ537

Chopper Regulator, DC–DC Converter and Motor Drive Applications

- Low drain-source ON resistance $RDS(ON) = 0.16 \Omega$ (typ.)
- High forward transfer admittance $|Y_{fs}| = 3.5 \text{ S (typ.)}$
- Low leakage current $: I_{DSS} = -100 \ \mu A (V_{DS} = -50 \ V)$
- Enhancement-mode : $V_{th} = -0.8 \sim -2.0 V (V_{DS} = -10 V, I_D = -1 mA)$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V _{DSS}	-50	V	
Drain-gate voltage (R _{GS} = 20 kΩ)		V _{DGR}	-50	V	
Gate-source voltage		V _{GSS}	±20	V	
Drain current	DC (Note 1)	۱ _D	-5	А	
	Pulse (Note 1)	I _{DP}	-15	А	
Drain power dissipation		PD	0.9	W	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	



Weight: 0.36 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient	R _{th (ch−a)}	138	°C / W

Note 1: Please use devices on condition that the channel temperature is below 150°C.

This transistor is an electrostatic sensitive device. Please handle with caution.

Unit: mm

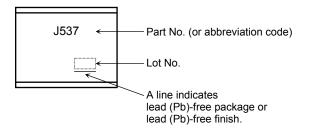
Electrical Characteristics (Ta = 25°C)

Charao	cteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V_{GS} = ±16 V, V_{DS} = 0 V	_	_	±10	μA
Drain cut-off cu	rrent	I _{DSS}	V_{DS} = -50 V, V_{GS} = 0 V	_		-100	μA
Drain−source br voltage	eakdown	V (BR) DSS	I _D = -10 mA, V _{GS} = 0 V	-50	_	_	V
Gate threshold v	voltage	V _{th}	V _{DS} = -10 V, I _D = -1 mA	-0.8	_	-2.0	V
Drain-source ON resistance		R _{DS (ON)}	V _{GS} = -4 V, I _D = -1.3 A	_	0.27	0.34	Ω
			V_{GS} = -10 V, I _D = -2.5 A	_	0.16	0.19	12
Forward transfe	r admittance	Y _{fs}	V_{DS} = -10 V, I _D = -2.5 A	1.5	3.5	_	S
Input capacitance	xe	C _{iss}		_	470	_	
Reverse transfer capacitance		C _{rss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz	_	60	_	pF
Output capacitance		C _{oss}] [210	_	
Switching time	Rise time	tr	$v_{GS}_{-10V} \downarrow \downarrow$	_	25	_	ns
	Turn-on time	t _{on}		_	35	_	
	Fall time	t _f		_	20	_	
	Turn-off time	t _{off}	$V_{DD} = -25V$ Duty $\leq 1\%$, t _w = 10 μ s	_	120	_	
Total gate charge (Gate-source plus gate-drain)		Qg	V _{DD} ≈ −40 V, V _{GS} = −10 V,	_	18	_	nC
Gate-source charge		Q _{gs}	$I_D = -5 A$	—	13	—	
Gate-drain ("miller") charge		Q _{gd}		—	5	—	

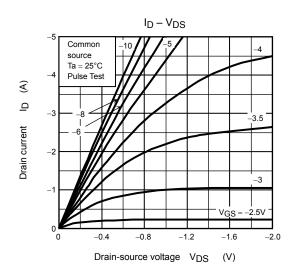
Source–Drain Ratings and Characteristics (Ta = 25°C)

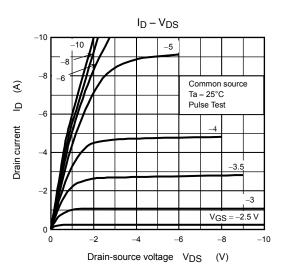
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	—	_	-	-5	А
Pulse drain reverse current (Note 1)	I _{DRP}	_	_	Ι	-15	А
Forward voltage (diode)	V _{DSF}	I _{DR} = -5 A, V _{GS} = 0 V		_	1.5	V

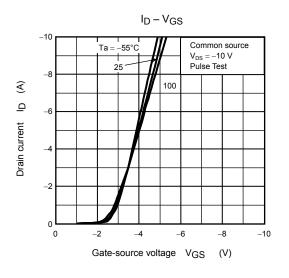
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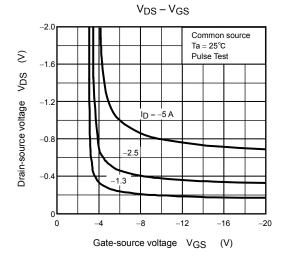


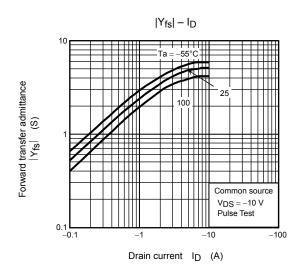
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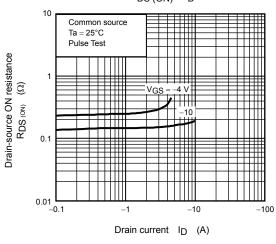


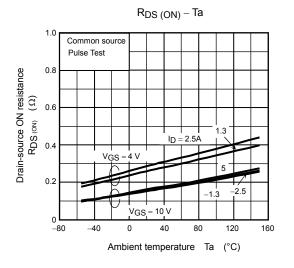


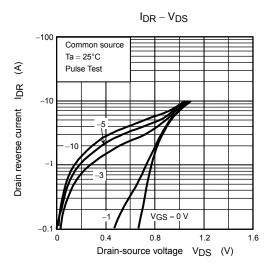


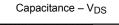


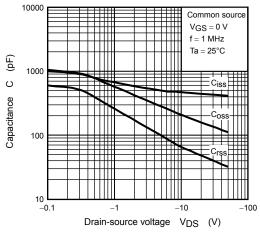
R_{DS (ON)} – I_D

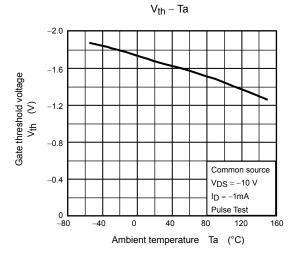


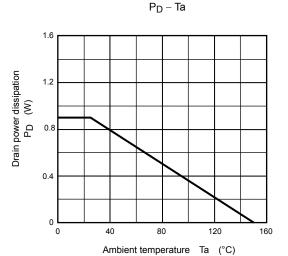




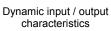


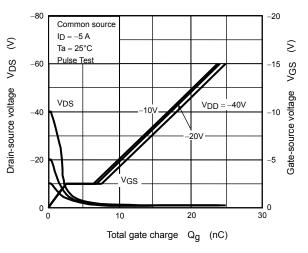


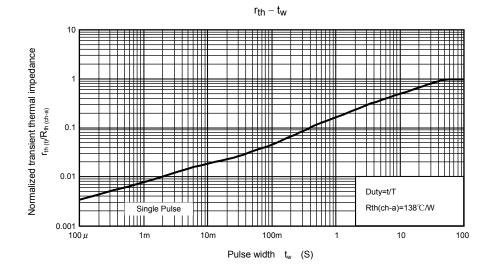


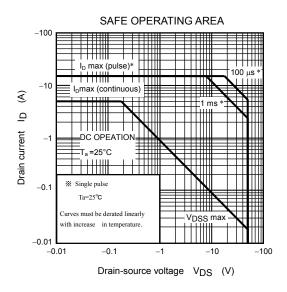












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